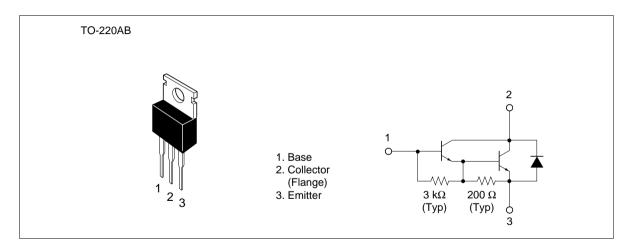
Silicon NPN Epitaxial

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Application

Medium speed and power switching complementary pair with 2SB727(K)

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	120	V
Collector to emitter voltage	V _{CEO}	120	V
Emitter to base voltage	V _{EBO}	7	V
Collector current	Ι _c	6	А
Collector peak current	C(peak)	10	А
Collector power dissipation	Pc*1	40	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

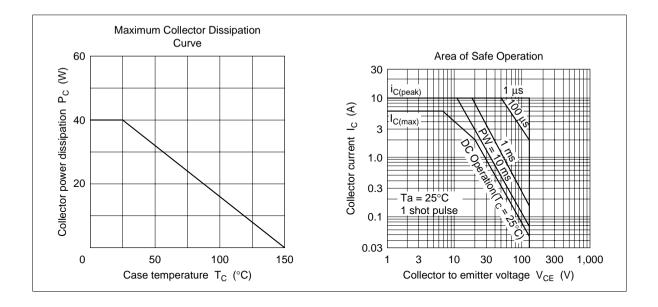
Note: 1. Value at $T_c = 25^{\circ}C$.

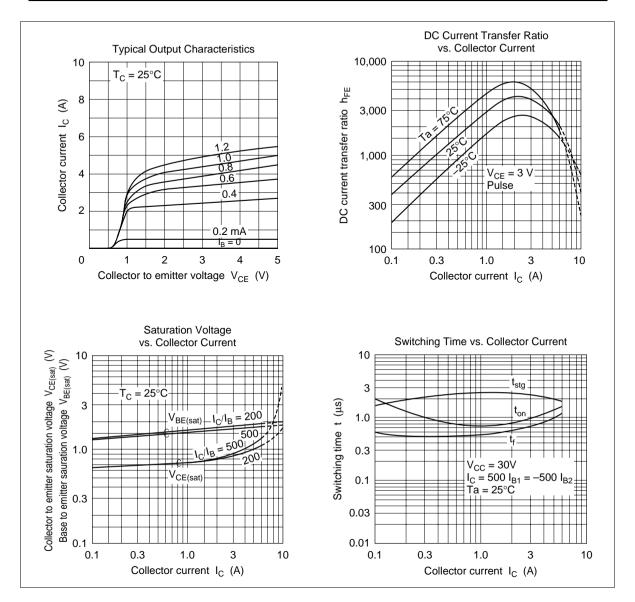


Electrical Characteristics (Ta = 25°C)

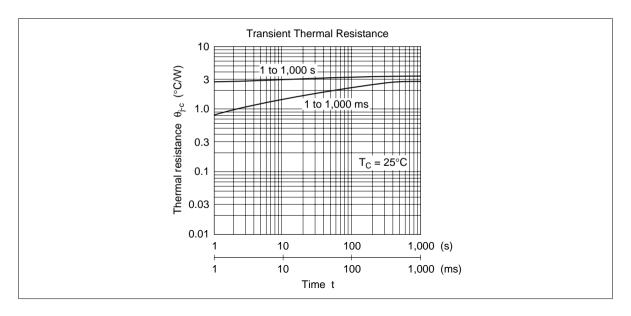
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	120	_	_	V	$I_c = 25 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{\rm (BR)EBO}$	7	_	—	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	—	100	μA	$V_{CB} = 120 \text{ V}, \text{ I}_{E} = 0$
	I _{CEO}		—	10	μA	V _{CE} = 100 V, R _{BE} =∞
DC current transfer ratio	h_{FE}	1000	—	20000		$V_{ce} = 3 \text{ V}, \text{ I}_{c} = 3 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	—	—	1.5	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	V _{CE(sat)2}		—	3	V	$I_{\rm C} = 6A, I_{\rm B} = 60 \text{ mA}^{*1}$
Base to emitter saturation	$V_{\text{BE(sat)1}}$		—	2	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	$V_{\text{BE(sat)2}}$	—	—	3.5	V	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 60 \text{ mA}^{*1}$
Turn on time	t _{on}		1.0	_	μs	$I_{\rm C} = 3 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 6 \text{ mA}$
Turn off time	t _{off}		3.0	—	μs	$I_{\rm C} = 3 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 6 \text{ mA}$

Note: 1. Pulse test.

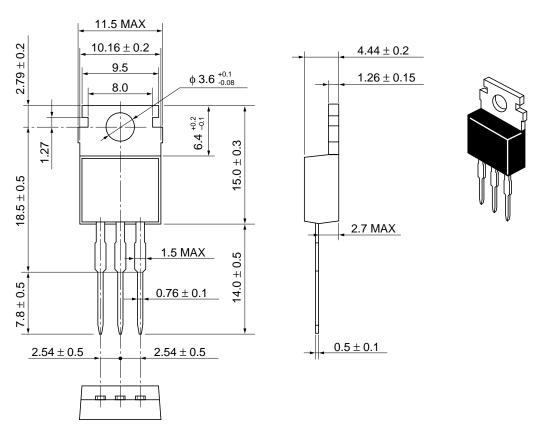




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Hitachi Code	TO-220AB
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.8 g

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